

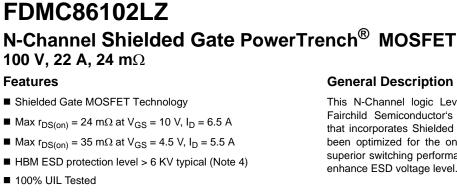
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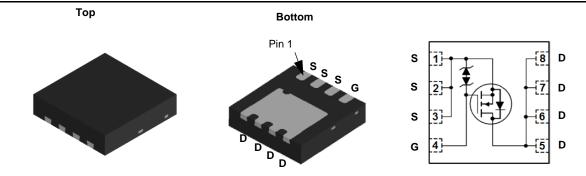


General Description

This N-Channel logic Level MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench® process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance. G-S zener has been added to enhance ESD voltage level.

Application

DC - DC Switching



MLP 3.3x3.3

MOSFET Maximum Ratings TA = 25 °C unless otherwise noted

Symbol	Param	eter		Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		22	_	
I _D	-Continuous	T _A = 25 °C	(Note 1a)	7	Α	
	-Pulsed			30		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	84	mJ	
P _D	Power Dissipation	T _C = 25 °C		41	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3		
T _J , T _{STG}	Operating and Storage Junction Tempera	ature Range		-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1	a) 53	0/11

Package Marking and Ordering Information

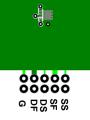
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC86102Z	FDMC86102LZ	Power 33	13 "	12 mm	3000 units

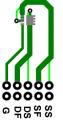
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May 2016

	FDMC86102LZ N-Char
2	N-Channel Shielded Gate PowerTrenc
	:h [®] MOS
	FET

	Test Conditions	Min	Тур	Max	Units
cteristics					
Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		71		mV/°C
Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			1	μA
Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
cteristics					
Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.0	1.6	2.2	V
Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C
Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$		19	24	
	$V_{GS} = 4.5 \text{ V}, \ I_D = 5.5 \text{ A}$		25	35	5 mΩ
	$V_{GS} = 10 \text{ V}, \ I_D = 6.5 \text{ A}, \ T_J = 125 \text{ °C}$		31	40	
Forward Transconductance	$V_{DS} = 5 \text{ V}, \ \text{I}_{D} = 6.5 \text{ A}$		24		S
Characteristics					
			969	1290	pF
			181	240	pF
Reverse Transfer Capacitance	T = 1 MHZ		9	15	pF
				10	P
Gate Resistance			0.4	10	Ω
Gate Resistance				10	
Gate Resistance Characteristics			0.4		Ω
Gate Resistance			0.4	15	Ω
Gate Resistance J Characteristics Turn-On Delay Time Rise Time	$V_{DD} = 50$ V, $I_D = 6.5$ A, V _{GS} = 10 V, R _{GEN} = 6 Ω		0.4 7.1 2.3	15 10	Ω ns ns
Gate Resistance J Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DD} = 50$ V, $I_D = 6.5$ A, V _{GS} = 10 V, R _{GEN} = 6 Ω		0.4 7.1 2.3 19	15 10 35	Ω ns ns ns
Gate Resistance J Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		0.4 7.1 2.3	15 10	Ω ns ns
Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		0.4 7.1 2.3 19 2.5	15 10 35 10	Ω ns ns ns ns
Gate Resistance J Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time			0.4 7.1 2.3 19 2.5 15.3	15 10 35 10 22	Ω ns ns ns nc
Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		0.4 7.1 2.3 19 2.5 15.3 7.6	15 10 35 10 22	Ω ns ns ns nc nC
Gate Resistance J Characteristics Turn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate ChargeTotal Gate ChargeTotal Gate ChargeTotal Gate ChargeGate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		0.4 7.1 2.3 19 2.5 15.3 7.6 2.4	15 10 35 10 22	Ω ns ns ns nC nC nC
Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge Ince Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 50 \text{ V},$ $I_{D} = 6.5 \text{ A}$		0.4 7.1 2.3 19 2.5 15.3 7.6 2.4	15 10 35 10 22	Ω ns ns nc nC nC nC
Gate Resistance J Characteristics Turn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate ChargeTotal Gate ChargeTotal Gate ChargeTotal Gate ChargeGate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 50 \text{ V},$ $I_{D} = 6.5 \text{ A}$		0.4 7.1 2.3 19 2.5 15.3 7.6 2.4 2.5	15 10 35 10 22 11	Ω ns ns ns nC nC nC
Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge Ince Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 50 \text{ V},$ $I_D = 6.5 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 6.5 \text{ A}$ (Note 2)		0.4 7.1 2.3 19 2.5 15.3 7.6 2.4 2.5 0.80	15 10 35 10 22 11 1.3	Ω ns ns nC nC nC
	Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current cteristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Static Drain to Source On Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance	Coefficient $I_D = 250 \ \mu A$, referenced to 25 °CZero Gate Voltage Drain Current $V_{DS} = 80 \ V, V_{GS} = 0 \ V$ Gate to Source Leakage Current $V_{GS} = \pm 20 \ V, V_{DS} = 0 \ V$ cteristicsGate to Source Threshold VoltageGate to Source Threshold Voltage $I_D = 250 \ \mu A$, referenced to 25 °CGate to Source Threshold Voltage $I_D = 250 \ \mu A$, referenced to 25 °CGate to Source Threshold Voltage $I_D = 250 \ \mu A$, referenced to 25 °CStatic Drain to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 6.5 \ A$ VGS = 10 V, I_D = 6.5 \ A $V_{GS} = 10 \ V, \ I_D = 6.5 \ A$ Forward Transconductance $V_{DS} = 5 \ V, \ I_D = 6.5 \ A$ Input Capacitance $V_{DS} = 50 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz$	CoefficientID $250 \ \mu\text{A}$, referenced to $25 \ \text{C}$ Zero Gate Voltage Drain Current $V_{DS} = 80 \ \text{V}, V_{GS} = 0 \ \text{V}$ Gate to Source Leakage Current $V_{GS} = \pm 20 \ \text{V}, \ \text{V}_{DS} = 0 \ \text{V}$ cteristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, \ I_D = 250 \ \mu\text{A}$ Gate to Source Threshold Voltage $I_D = 250 \ \mu\text{A}, \ referenced to 25 \ ^{\circ}\text{C}Gate to Source Threshold VoltageI_D = 250 \ \mu\text{A}, \ referenced to 25 \ ^{\circ}\text{C}Gate to Source Threshold VoltageI_D = 250 \ \mu\text{A}, \ referenced to 25 \ ^{\circ}\text{C}Static Drain to Source On ResistanceV_{GS} = 10 \ \text{V}, \ I_D = 6.5 \ \text{A}V_{GS} = 10 \ \text{V}, \ I_D = 6.5 \ \text{A}, \ T_J = 125 \ ^{\circ}\text{C}Forward TransconductanceV_{DS} = 5 \ \text{V}, \ I_D = 6.5 \ \text{A}CharacteristicsInput CapacitanceOutput CapacitanceV_{DS} = 50 \ \text{V}, \ V_{GS} = 0 \ \text{V}, \ f = 1 \ \text{MHz}$	CoefficientID250 µA, referenced to 25 °C71Zero Gate Voltage Drain Current $V_{DS} = 80 V, V_{GS} = 0 V$ Gate to Source Leakage Current $V_{GS} = \pm 20 V, V_{DS} = 0 V$ cteristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = 250 \mu A$ 1.0Gate to Source Threshold Voltage $I_D = 250 \mu A$, referenced to 25 °C-6Gate to Source Threshold Voltage $I_D = 250 \mu A$, referenced to 25 °C-6Temperature Coefficient $V_{GS} = 10 V, I_D = 6.5 A$ 19Static Drain to Source On Resistance $V_{GS} = 4.5 V, I_D = 5.5 A$ 25 $V_{GS} = 10 V, I_D = 6.5 A, T_J = 125 °C$ 31Forward Transconductance $V_{DS} = 5 V, I_D = 6.5 A$ 24CharacteristicsInput Capacitance $V_{DS} = 50 V, V_{GS} = 0 V, f_S = 0 V, f_S = 10 Hz$ 969Output Capacitance $V_{DS} = 50 V, V_{GS} = 0 V, f_S = 10 Hz$ 181	CoefficientID $250 \ \mu$ A, referenced to $25 \ C$ 71Zero Gate Voltage Drain Current $V_{DS} = 80 \ V, V_{GS} = 0 \ V$ 1Gate to Source Leakage Current $V_{GS} = \pm 20 \ V, V_{DS} = 0 \ V$ ± 10 cteristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, \ I_D = 250 \ \mu$ A1.01.62.2Gate to Source Threshold Voltage $I_D = 250 \ \mu$ A, referenced to $25 \ ^{\circ}$ C-6-6Gate to Source Threshold Voltage $I_D = 250 \ \mu$ A, referenced to $25 \ ^{\circ}$ C-6-6Static Drain to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 6.5 \ A$ 1924V_{GS} = 10 \ V, \ I_D = 6.5 \ A2535-6V_{GS} = 10 \ V, \ I_D = 6.5 \ A24-24-6CharacteristicsInput Capacitance $V_{DS} = 50 \ V, \ V_{GS} = 0 \ V, \ I_B = 6.5 \ A$ 24Input Capacitance $V_{DS} = 50 \ V, \ V_{GS} = 0 \ V, \ I_B = 1 \ MHz$ 9691290





3. Starting T_J = 25 °C; N-ch: L = 1 mH, I_{AS} = 13 A, V_{DD} = 90 V, V_{GS} = 10 V.

4. The diode connected between gate and source serves only as protection against ESD. No gate overvoltage rating is implied.



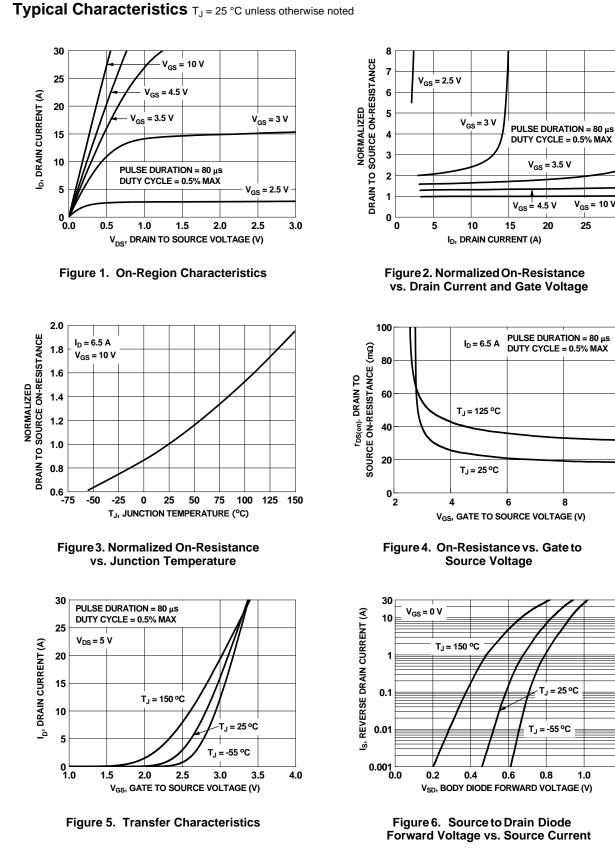
V_{GS} = 10 V

25

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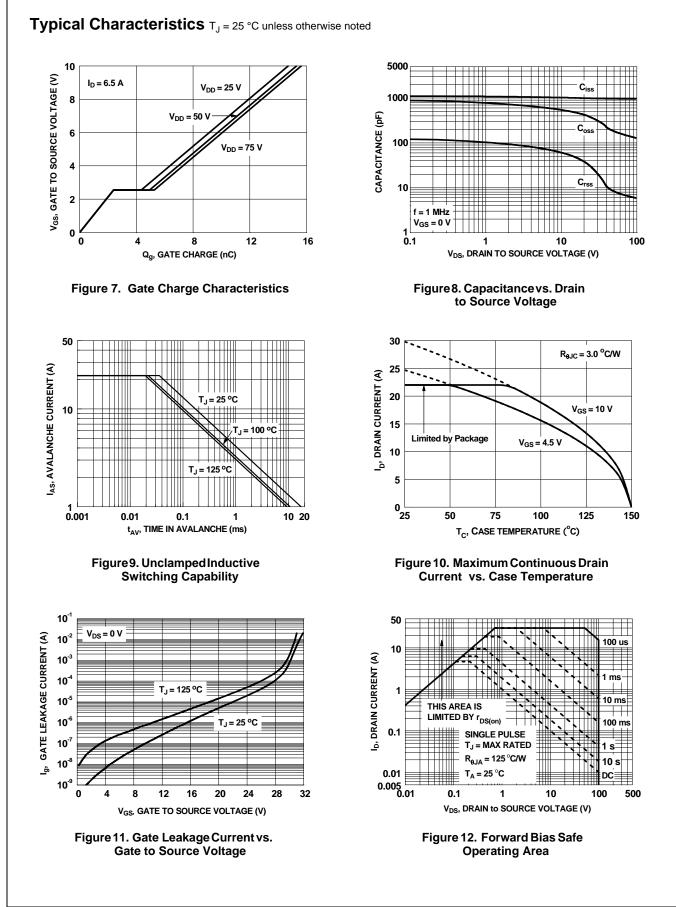
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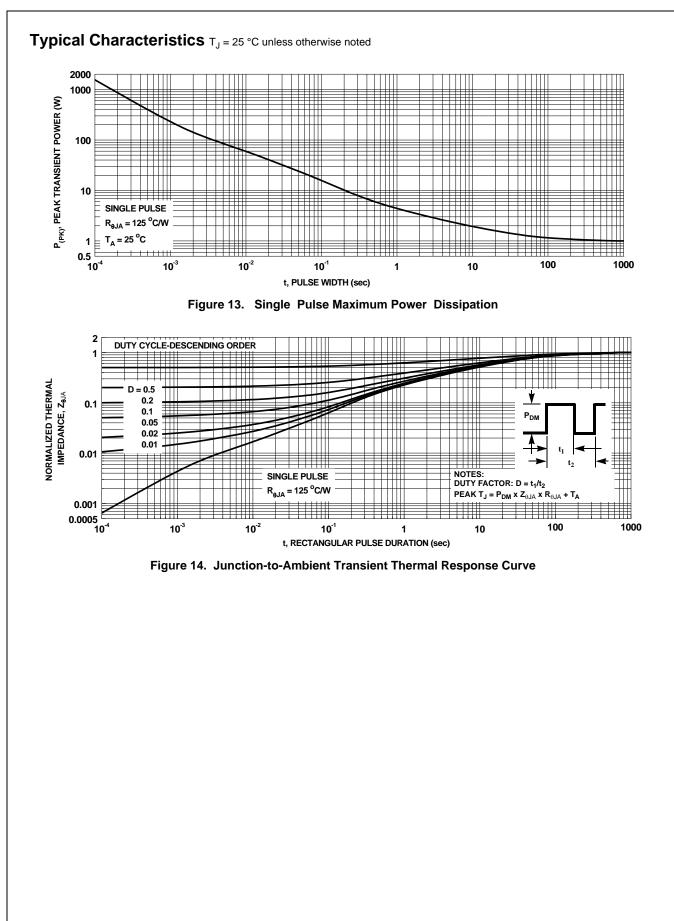
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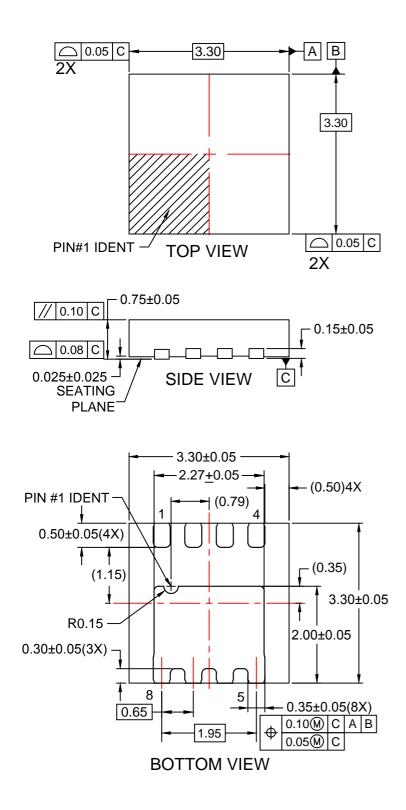
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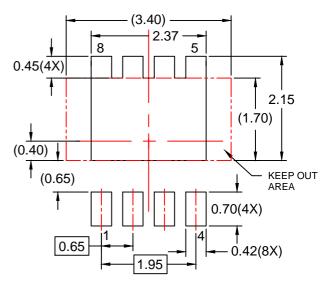
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RECOMMENDED LAND PATTERN

NOTES:

- A. DOES NOT CONFORM TO JEDEC REGISTRATION MO-229
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-MLP08Srev3.



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